

20V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on)} max	I_D max $T_A = 25$ °C (Notes 4 & 7)		
20V	120mΩ @ V _{GS} = 4.5V	3.7A		
20 V	300mΩ @ V _{GS} = 2.5V	2.3A		

Description and Applications

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

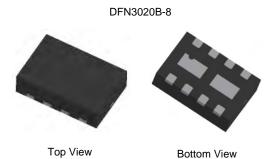
- DC-DC Converters
- Power management functions
- Disconnect switches
- · Portable applications

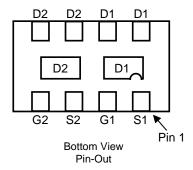
Features and Benefits

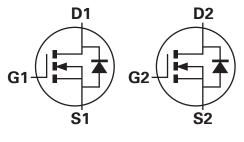
- Low profile package, for thin applications
- Low Rthj-a, thermally efficient package
- 6mm² footprint, 50% smaller than TSOP6 and SOT23-6
- Low on-resistance
- Fast switching speed
- "Lead-Free", RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: DFN3020B-8
- Terminals: Pre-Plated NiPdAu leadframe
- Nominal package height: 0.8mm
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Solderable per MIL-STD-202, Method 208
- Weight: 0.013 grams (approximate)







Equivalent Circuit

Ordering Information (Note 3)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXMN2AMCTA	DNA	7	8	3000

Notes:

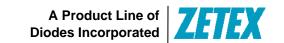
- 1. No purposefully added lead
- 2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



DNA = Product Type Marking Code Top View, Dot Denotes Pin 1





Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic			Symbol	Value	Unit	
Drain-Source Voltage			V_{DSS}	20	V	
Gate-Source Voltage			V _{GSS}	±12	V	
		(Notes 4 & 7)		3.7		
Continuous Drain Current	$V_{GS} = 4.5V$	T _A = 70°C (Notes 4 & 7)	I _D	3.0		
		(Notes 3 & 7)		2.9		
Pulsed Drain Current	$V_{GS} = 4.5V$	(Notes 6 & 7)	I _{DM}	13	А	
Continuous Source Current (Body diode) (Notes 4 & 7)		(Notes 4 & 7)	Is	3.0		
Pulse Source Current (Body diode) (Notes 6 & 7)		I _{SM}	13			

Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit		
·	(Notes 3 & 7)		1.50 12		
Power Dissipation	(Notes 4 & 7)		2.45 19.6	W mW/°C	
Linear Derating Factor	(Notes 5 & 7)	P _D	1.13 9		
	(Notes 5 & 8)		1.70 13.6		
	(Notes 3 & 7)		83.3		
The arrest Decister of the Archivet	(Notes 4 & 7)		51.0		
Thermal Resistance, Junction to Ambient	(Notes 5 & 7)	R _{0JA}	111	°C/W	
	(Notes 5 & 8)		73.5		
Thermal Resistance, Junction to Lead	(Notes 7 & 9)	R _{0JL}	17.1		
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C	

Notes:

- For a device surface mounted on 28mm x 28mm (8 sq cm) FR4 PCB with high coverage of single sided 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition. The heatsink is split in half with the exposed drain pads connected to each half.
 Same as note (3) except the device is measured at t < 5 sec.

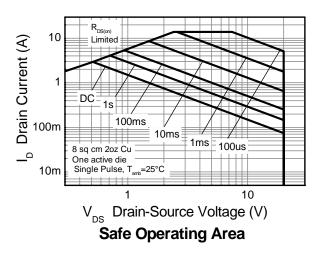
- 5. Same as note (3), except the device is surface mounted on 31mm x 31mm (10 sq cm) FR4 PCB with high coverage of single sided 1oz copper.

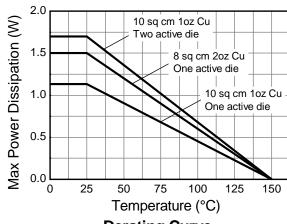
 6. Same as note (3), except the device is pulsed with D = 0.02 and pulse width 300 μs. The pulse current is limited by the maximum junction temperature.

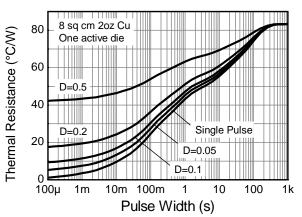
 7. For a dual device with one active die.
- 8. For dual device with 2 active die running at equal power.
- 9. Thermal resistance from junction to solder-point (at the end of the drain lead).



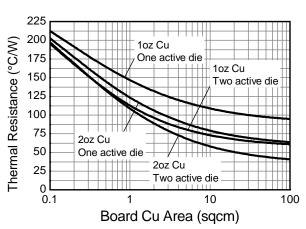
Thermal Characteristics



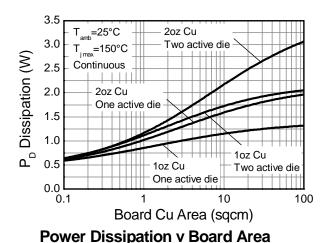




Derating Curve

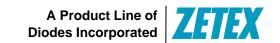


Transient Thermal Impedance



Thermal Resistance v Board Area





Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test C	ondition
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV _{DSS}	20	-	-	V	$I_D = 250 \mu A, V_{GS}$	V0 = 8
Zero Gate Voltage Drain Current	I _{DSS}	-	-	1	μΑ	$V_{DS} = 20V, V_{GS}$; = 0V
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 12V, V_{D}$	os = 0V
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(th)}	0.7	-	3.0	V	$I_D = 250 \mu A, V_{DS}$	$s = V_{GS}$
Static Drain Source On Decistores (Note 10)			0.085	0.120	Ω	$V_{GS} = 4.5V, I_D = 4A$	
Static Drain-Source On-Resistance (Note 10)	R _{DS (ON)}	-	0.140	0.300		$V_{GS} = 2.5V, I_D = 1.5A$	
Forward Transconductance (Note 10 & 11)	9 _{fs}	-	6.2	-	S	$V_{DS} = 10V, I_{D} =$	4A
Diode Forward Voltage (Note 10)	V _{SD}	-	0.9	0.95	V	I _S = 3.2A, V _{GS} =	= 0V
Reverse Recover Time (Note 11)	t _{rr}	-	23	-	ns	I _S = 4A, di/dt = 100A/μs	
Reverse Recover Charge (Note 11)	Q _{rr}	-	5.7	-	nC		
DYNAMIC CHARACTERISTICS (Note 11)		•	•				
Input Capacitance	C _{iss}	-	299	-	pF	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss	-	60	-	pF		
Reverse Transfer Capacitance	Crss	-	33	-	pF		
Total Gate Charge (Note 12)	Qq	-	0.8	-	nC	$V_{GS} = 2.5V$	
Total Gate Charge (Note 12)	Qq	-	3.1	-	nC		$V_{DS} = 10V$
Gate-Source Charge (Note 12)	Q _{qs}	-	0.7	-	nC	$V_{GS} = 4.5V \qquad I_{D} = 4A$	
Gate-Drain Charge (Note 12)	Q _{qd}	-	1.0	-	nC		
Turn-On Delay Time (Note 12)	t _{D(on)}	-	2.3	-	ns	$V_{DS} = 10V, I_{D} = 4A$ $V_{GS} = 5V, R_{G} = 6\Omega$	
Turn-On Rise Time (Note 12)	t _r	-	2.6	-	ns		
Turn-Off Delay Time (Note 12)	t _{D(off)}	-	1.6	-	ns		
Turn-Off Fall Time (Note 12)	t _f	-	1.3	-	ns		

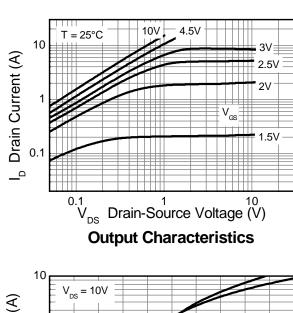
Notes:

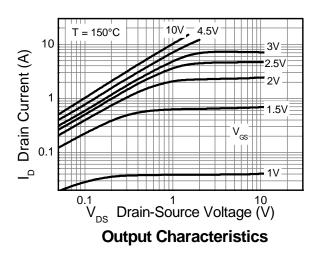
- 10. Measured under pulsed conditions. Width \leq 300 μ s. Duty cycle \leq 2%.
- 11. For design aid only, not subject to production testing.

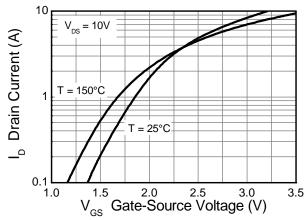
 12. Switching characteristics are independent of operating junction temperature.

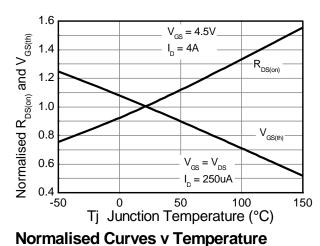


Typical Electrical Characteristics

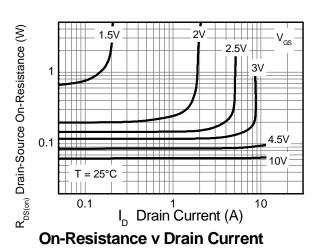








Typical Transfer Characteristics



T = 150°C

T = 25°C

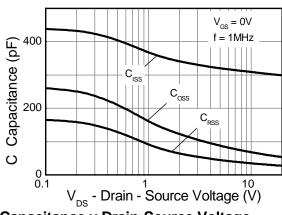
O.4

V_{SD} Source-Drain Voltage (V)

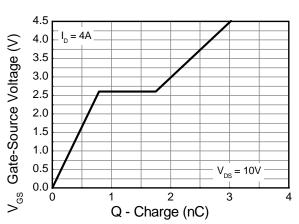
Source-Drain Diode Forward Voltage



Typical Electrical Characteristics - Continued

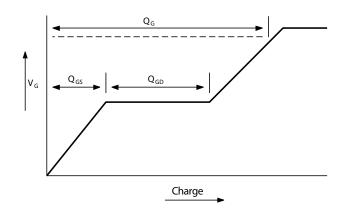


Capacitance v Drain-Source Voltage

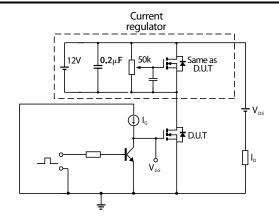


Gate-Source Voltage v Gate Charge

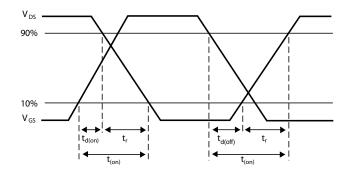
Test Circuits



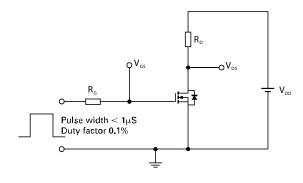
Basic gate charge waveform



Gate charge test circuit



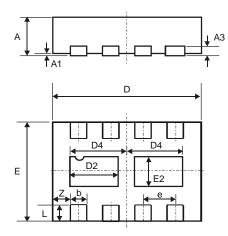
Switching time waveforms



Switching time test circuit

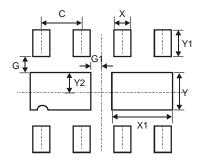


Package Outline Dimensions



DFN3020B-8						
Dim	Min	Max	Тур			
Α	0.77	0.83	0.80			
A1	0	0.05	0.02			
А3	-	-	0.15			
b	0.25	0.35	0.30			
D	2.95	3.075	3.00			
D2	0.82	1.02	0.92			
D4	1.01	1.21	1.11			
е	-	-	0.65			
Е	1.95	2.075	2.00			
E2	0.43	0.63	0.53			
L	0.25	0.35	0.30			
Z	-	-	0.375			
All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)
С	0.650
G	0.285
G1	0.090
Х	0.400
X1	1.120
Y	0.730
Y1	0.500
٧2	0.365





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